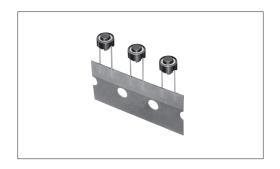


6.2mm Diameter Round Terminal (Radial Type)





Round terminal vertical type with excellent PC board mounting performance.



Typical Specifications

Items	Specifications
Rating (max.)	50mA 12V DC
Rating (min.)	10μA 1V DC
Initial contact resistance	500mΩ max.
Travel (mm)	0.25

Detector

Push

Slide

Rotary

Encoders

Power

Dual-in-line

Package Type TACT Switch™

Sharp Feeling Soft Feeling

Snap-in

Type

Surface

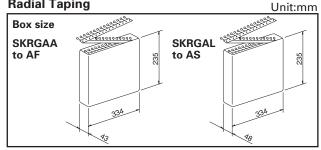
Radial Type

Mount Type

Product Line

Product No.	Operating	Operating	Operating life	Stem color	Stem height	Minimum ord	ler unit (pcs.)
Product No.	force	direction	(5mA 5V DC)	Stem color	Stem neight	Japan	Export
SKRGAAD010	1.27N		500,000cycles	Black			
SKRGABD010	1.57N		500,000cycles	White	h=4.3mm		
SKRGACD010	2.55N		200,000cycles	Gray			
SKRGADD010	1.27N		500,000cycles	Black		- 2,000	2,000
SKRGAED010	1.57N	Toppush 200,0		White	h=5mm		
SKRGAFD010	2.55N		200,000cycles	Gray			
SKRGALD010	1.27N		E00 000 ovoloo	Black			
SKRGAMD010	1.57N		500,000cycles	White	h=7mm		
SKRGAND010	2.55N		200,000cycles	Gray			
SKRGAQD010	1.27N		500,000cycles	Black			
SKRGARD010	1.57N		500,000cycles	White	h=9.5mm		
SKRGASD010	2.55N		200,000cycles	Gray			

Packing Specifications **Radial Taping**



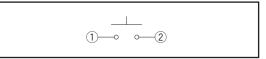
Numbe	Export package		
1 box	1 case / Japan	1 case / export packing	measurements (mm)
2.000	20.000	20.000	SKRGAA to AF 353 × 506 × 244
2,000	20,000	20,000	SKRGAL to AS 353 × 506 × 269

D	П	m	е	n	S	IO	n	S

	U	n	I	t:	r	n	r	r	1
_	_	_	-	_	-	_		-	7

Style	PC board mounting hole dimensions (Viewed from switch mounting face)
12.7 Stem h A 4.3 3.4 5 3.4 5 3.4 7 3.2 9.5 2.9	- 5 - Sol Holes

Circuit Diagram



Please use 1.6mm thick PC boards.

TACT Switch™

List of Varieties

Detector Push Slide **Rotary Encoders** Power Dual-in-line Package Type TACT Switch™

Sharp Feeling Soft **Feeling**

Snap-in Type Surface **Mount Type**

Radial Type

	_	Shar	p Feeling	Туре				Soft Fee	ling Type			
	Туре		Radial			Snap-in		Su	rface Mo	unt	Rad	dial
	Series	SKRG	SKGK	SKRC	SKEG	SKEG	SKPF	SKPM	SKPG	SKPR	SKPL	SKPD
	Photo		***	444								
	Features	Round terminal type	_	Round terminal type	_	_	High operation force and long travel	Low contact resistance	_	and Low contact resistance	Round terminal and low contact resistance	_
\ w	ater-proof	_	_	•	_	_	_	_	_	_	_	_
	Oust-proof	_	_	•	_	_	_	_	_	_	_	_
Operatir	Toppush	•	•	•	•	_	•	•	•	•	•	•
directio		_	_	_		•	_	_	_	_	_	_
	W	,,,,				7.5	8	5.9	6.6	7.5	10.15	
Dimensio (mm)	ns D	φ6.2	□ 6.6	<i>φ</i> 9	□6	9.9	9	6	6.3	7.8	φ6.45	□7.8
(,	Н	4.3	5	13	7	7.3	10	Ę	5	6.5	5	5
	Contact	_	_	_		Carbon		Silver	Carbon	Silver	Car	bon
Operation force coverage	2N~3N	1	1	1	1	1	1	1	1		1	
	4N~5N									\$		
Т	ravel (mm)		0.25		1 *1			1.3 1		1	1.3	% 1
Gro	und terminal	_	_	_	_	_	_	_	_	_	_	_
Operat	ing temperature range	- 40°C to + 90°C	- 20°C to + 70°C	- 40°C to + 90°C	−20°C to	+70°C			−40°C to	+90°C		
Aut	omotive use	•	_	_	_	_	•	•	•	•	•	•
ı	Life Cycle	* 2	* 2	* 2	* 2	* 2	* 2	*3	*3	*3	* 2	* 2
	Rating (max.) (Resistive load)	50)mA 12V [OC	5	mA 12V D	C	50mA 16V DC	5mA 12V DC		mA DC	5mA 12V DC
Electrical	Rating (min.) (Resistive load)	1	0 μ A 1V D	С				10 μ A	1V DC			
performance	Insulation resistance	100M	Ω min. 100 for 1min.	OV DC			1001	/IΩ min. 10	0V DC for	1min.		
	Voltage proof	250	V AC for 1	min.	250V AC for 1min.			 2				
	Vibration	10 to 55 to 10h for all the free X Y and	dz/min., the ampl quencies, in the Z for 2hours res	litude is 1.5mm 3 direction of	10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2hours respectively		uencies,	% 3				
Durability -	Lifetime	Shall be	in accorda	nce with	with Shall be in accordance with individual specification		tions.					
	Cold	-40±2℃ for 96h	-30±2°C for 96h	-40±2°C for 96h	- 30±2°C	C for 96h	-40±2℃ for 96h	- 30	0±2°C for	96h	-40 ± 2°C for 1000h	-40 ± 2°C for 96h
Environmental performance	Dry heat	90±2°C for 96h	80±2°C for 96h	90±2°C for 96h	80±2℃	for 96h	90 ± 2°C for 96h	80	±2°C for 9	6h	90 ± 2°C for 1000h	90 ± 2°C for 96h
	Damp heat	60± 90 to 95%	2℃ , RH for 96h	60 ± 2°C . 90 to 95%RH for 1000h		60±	2°C , 90 to	95%RH fo	r 96h		60 ± 2°C, 90 to 95%RH for 1000h	60 ± 2°C, 90 to 95%RH for 96h
	Page	277	278	279	280	280	282	283	284	285	286	287
						10/ - 10	C IVI TI			n excludii		Larration

W: Width. The most outer dimension excluding terminal portion.

D: Depth. The most outer dimension excluding terminal portion. H: Height. The minimum dimension if there are variances.

 TACT Switch[™] Soldering Conditions
 TACT Switch[™] Cautions 289

- 1. The automotive operating temperature range to be individually discussed upon request.

- Indicates applicability to all products in the series.
 ※ 1 See the relevant pages for respective product descriptions
 ※ 2 50MΩ min. 100V DC for 1min. SKPDAF:100MΩmin. 100V DC for 1min.
 ※ 3 100V AC for 1min.SKPDAF:250V DC for 1min.

TACT Switch™ Soldering Conditions

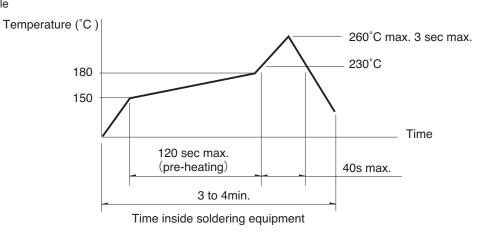
Condition for Reflow

Available for Surface Mount Type.

- 1. Heating method: Double heating method with infrared heater.
- 2. Temperature measurement: Thermocouple 0.1 to 0.2 ϕ CA (K) or CC (T) at solder joints (copper foil surface) .

A heat resistive tape should be used to fix thermocouple.

3. Temperature profile



Notes

Detector

Push

Slide

Rotary

Encoders

Power

Dual-in-line Package Type

TACT Switch™

Sharp Feeling Soft

Feeling Snap-in Type Surface Mount Type

Radial Type

- 1. The above temperature shall be measured of the top of switch. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others. The above-stated conditions shall also apply to switch surface temperatures.
- 2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Conditions for Auto-dip Available for Snap-in Type and Radial Type

Items	Condition				
Flux built-up	Mounting surface should not be exposed to fluk				
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.				
Preheating time	60s max.				
Soldering temperature	260°C max.				
Duration of immersion	5s max.				
Number of soldering	2times max.				

SKHH、SKPD Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to fluk
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKQJ、SKQK、SKEG Series

Shar, Shar, Shara Selles				
Items	Condition			
Flux built-up	Mounting surface should not be exposed to fluk			
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.			
Preheating time	45s max.			
Soldering temperature	255℃ max.			
Duration of immersion	5s max.			
Number of soldering	2times max.			

Manual Soldering (Except SKRT Series)

Items	Condition		
Soldering temperature	350°C max.		
Duration of soldering	3s max.		
Capacity of soldering iron	60W max.		

SKHH、SKHW、SKRG、SKPD Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKQJ、SKQK、SKEG Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

Notes

- 1. Consult with us for availability of TACT Switch[™] washing.
- 2. Prevent flux penetration from the top side of the TACT Switch $^{\text{TM}}$.
- 3. Switch terminals and a PC board should not be coated with flux prior to soldering.
- The second soldering should be done after the switch is stable with normal temperature.
- 5. Use the flux with a specific gravity of min 0.81. (EC-19S-8 by TAMURA Corporation, or equivalents.)